

PATENT ASSIGNMENT

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| Shinji HAYAKAWA | 03/15/2011 |
| Yasushi KOHNO | 03/15/2011 |
| RECEIVING PARTY DATA | |
| Name: | MIRAPRO CO., LTD. |
| Street Address: | 1100 Anadaira, Sutama-cho |
| City: | Hokuto-shi, Yamanashi |
| State/Country: | JAPAN |
| Postal Code: | 4080111 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 13073744 |
| CORRESPONDENCE DATA | |
| Fax Number: | (408)255-8002 |
| <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> | |
| Phone: | 408-255-8001 |
| Email: | mpascual@beyerlaw.com |
| Correspondent Name: | Beyer Law Group LLP |
| Address Line 1: | P.O Box 1687 |
| Address Line 4: | Cupertino, CALIFORNIA 95015 |
| ATTORNEY DOCKET NUMBER: | AIGIP008 |
| NAME OF SUBMITTER: | Steve D Beyer |
| Total Attachments: 2 source=AIGIP008_Assignment_MIRAPRO#page1.tif source=AIGIP008_Assignment_MIRAPRO#page2.tif | |

CH \$40.00 13073744

ASSIGNMENT OF PATENT APPLICATION

Whereas I, an undersigned inventor, have invented certain new and useful improvements as set forth in the patent application entitled:

CONNECTED STRUCTURE OF VACUUM DOUBLE PIPE, VACUUM DOUBLE PIPE, AND JOINT OF VACUUM DOUBLE PIPE

(Atty. Docket No. AIGIP008), (check one)

- for which I have executed a U.S. patent application. (Accompanying)
 which bears U.S. application No. 13/073,744. (Not accompanying)
 which is a U.S. provisional application. (Accompanying)

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, an undersigned inventor, hereby:

- 1) Sell, assign and transfer to MIRAPRO CO., LTD, a Japanese corporation having a place of business at 1100 Anadaira, Sutama-cho, Hokuto-shi, Yamanashi 4080111, Japan ("ASSIGNEE"), the entire right, title and interest in any and all improvements and inventions disclosed in, applications based upon, and patents granted upon (including foreign patents and the right to claim priority), the above-referenced application.
- 2) Authorize and request the Commissioner of Patents to issue any and all United States Patents resulting from said application or any division, continuation, substitute, renewal, re-examination or reissue thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representatives, and shall be binding upon the inventor, as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that I have not entered and will not enter into any assignment, contract, or understanding that conflicts with this assignment.
- 6) Authorize and request my attorney/agent to insert above the application No. in order to assist with recordal of this assignment.

Signed on the date indicated beside my signature.

- | | | |
|----|-----------------------------------|-----------------------------|
| 1) | Signature: <u>Shinji HAYAKAWA</u> | Date: <u>March 15, 2011</u> |
| | Typed Name: Shinji HAYAKAWA | |
| 2) | Signature: <u>Yasushi KOHNO</u> | Date: <u>March 15, 2011</u> |
| | Typed Name: Yasushi KOHNO | |

If signed outside the United States of America, have two witnesses who also sign below:

- 1) Signature: _____ Date: _____
Printed Name: _____

- 2) Signature: _____ Date: _____
Printed Name: _____